Quad 2-input multiplexer; 3-state Rev. 6 — 26 January 2015

Product data sheet

General description 1.

The 74HC257; 74HCT257 are high-speed Si-gate CMOS devices and are pin compatible with Low-power Schottky TTL (LSTTL).

The 74HC257 and 74HCT257 have four identical 2-input multiplexers with 3-state outputs, which select 4 bits of data from two sources and are controlled by a common data select input (S).

The data inputs from source 0 (110 to 410) are selected when input S is LOW and the data inputs from source 1 (111 to 411) are selected when S is HIGH. Data appears at the outputs (1Y to 4Y) in true (non-inverting) form from the selected inputs.

The 74HC257 and 74HCT257 are the logic implementation of a 4-pole, 2-position switch, where the position of the switch is determined by the logic levels applied to S. The outputs are forced to a high-impedance OFF-state when OE is HIGH.

The logic equations for the outputs are:

- $1\overline{Y} = \overline{OE} \bullet (111 \bullet S \bullet 110 \bullet \overline{S})$
- $2\overline{Y} = \overline{OE} \bullet (2II \bullet S \bullet 2IO \bullet \overline{S})$
- $3\overline{Y} = \overline{OE} \bullet (3I1 \bullet S \bullet 3I0 \bullet \overline{S})$
- $4\overline{Y} = \overline{OE} \bullet (4I1 \bullet S \bullet 4I0 \bullet \overline{S})$

Except for their non-inverting (true) outputs the 74HC257; 74HCT257 are identical to the 74HC258.

Features and benefits 2.

- Non-inverting data path
- 3-state outputs interface directly with system bus
- Complies with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

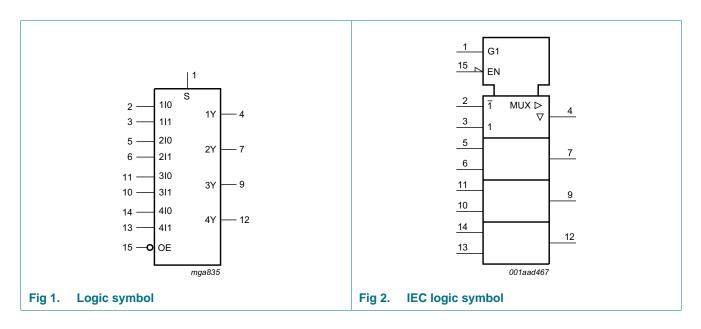


3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC257N	–40 °C to +125 °C	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4
74HCT257N				
74HC257D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HCT257D				
74HC257DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads;	SOT338-1
74HCT257DB			body width 5.3 mm	
74HC257PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1
74HCT257PW			body width 4.4 mm	

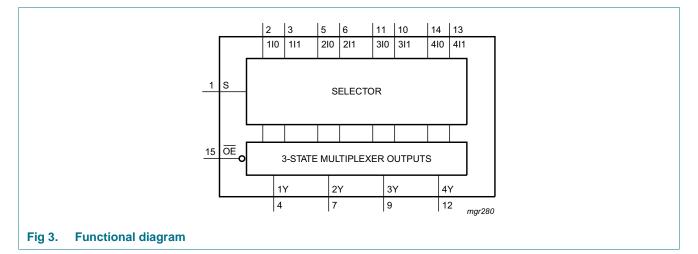
4. Functional diagram

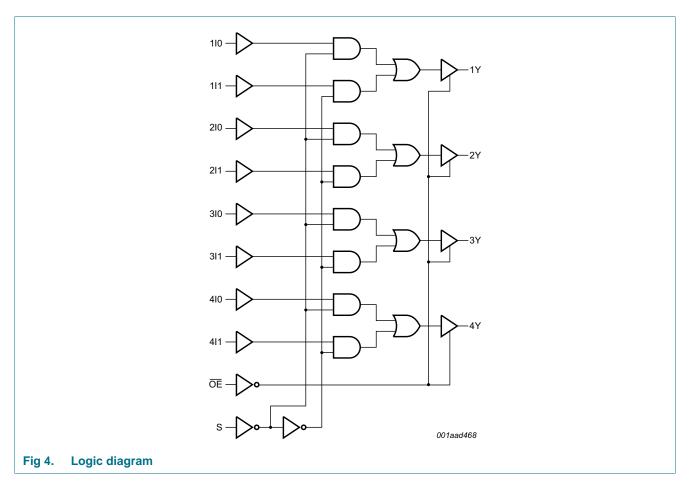


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74HC257; 74HCT257

Quad 2-input multiplexer; 3-state



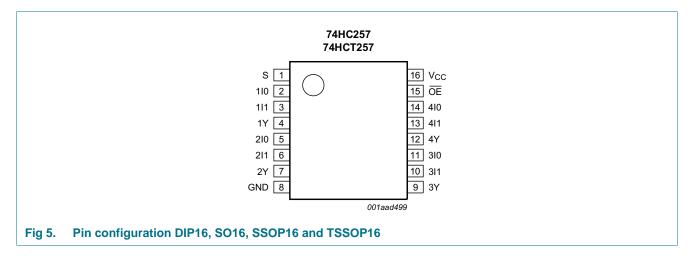


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Product data sheet

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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
S	1	common data select input
110 to 410	2, 5, 11, 14	data input from source 0
111 to 411	3, 6, 10, 13	data input from source 1
1Y to 4Y	4, 7, 9, 12	3-state multiplexer output
GND	8	ground (0 V)
OE	15	3-state output enable input (active LOW)
V _{CC}	16	supply voltage

6. Functional description

6.1 Function table

Table 3. Function table ^[1]										
		Input	Output							
OE	S	nl0	nl1	nY						
Н	Х	Х	Х	Z						
L	Н	Х	L	L						
L	Н	Х	Н	Н						
L	L	L	Х	L						
L	L	Н	Х	Н						

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5 V \text{ or}$ $V_{I} > V_{CC} + 0.5 V$	-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 V \text{ or}$ $V_{O} > V_{CC} + 0.5 V$	-	±20	mA
I _O	output current	$V_{O} = -0.5$ V to V_{CC} + 0.5 V	-	±35	mA
I _{CC}	supply current		-	+70	mA
I _{GND}	ground current		-	-70	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation				
		DIP16 package	<u>[1]</u> _	750	mW
		SO16 package	[2] _	500	mW
		SSOP16 package	<u>[3]</u>	500	mW
		TSSOP16 package	<u>[3]</u>	500	mW

[1] For DIP16 packages: above 70 °C, Ptot derates linearly with 12 mW/K.

[2] For SO16 packages: above 70 $^\circ\text{C},$ P_tot derates linearly with 8 mW/K.

[3] For SSOP16 and TSSOP16 packages: above 60 °C, P_{tot} derates linearly with 5.5 mW/K.

8. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
74HC257					I	
V _{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
Δt/ΔV	input transition rise and fall rates	V _{CC} = 2.0 V	-	-	625	ns
		V _{CC} = 4.5 V	-	1.67	139	ns
		V _{CC} = 6.0 V	-	-	83	ns
T _{amb}	ambient temperature		-40	-	+125	°C
74HCT257			I			
V _{CC}	supply voltage		4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
Δt/ΔV	input transition rise and fall rates	V _{CC} = 4.5 V	-	1.67	139	ns
T _{amb}	ambient temperature		-40	-	+125	°C

Table 5. Recommended operating conditions

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC25	7	1	I							
VIH	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
VIL	LOW-level	$V_{CC} = 2.0 V$		0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I _O = 6.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 7.8 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±0.1	-	±1.0	±1.0	±1.0	μA
I _{OZ}	OFF-state output current		-	-	±0.5	-	±5.0	±10.0	±10.0	μΑ
I _{CC}	supply current		-	-	8.0	-	80	160	160	μA
Ci	input capacitance		-	3.5	-					pF
74HCT2	57	1								1
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
∨он	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -6 \text{ mA}$	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				-	0.1	-	0.1	1
	output voltage	I _O = 20 μA	-	0	0.1	-	0.33	-	0.4	V
		$I_0 = 6.0 \text{ mA}$	-	0.15	0.26	-	±1.0	-	±1.0	V
I _I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	-	±5.0	-	±10	μA

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Table 6. Static characteristics continued	Table 6.	Static	characteristics	continued
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At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	rameter Conditions		25 °C			–40 °C to +85 °C		–40 °C to +125 °C	
				Тур	Max	Min	Max	Min	Max	
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 5.5 \text{ V};$ $V_{O} = V_{CC} \text{ or GND per input}$ pin; other inputs at V _{CC} or GND; I _O = 0 A	-	-	±0.5	-	80	-	160	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0					μΑ
Δl _{CC}	additional supply current	$V_{I} = V_{CC} - 2.1 \text{ V};$ other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V; I _O = 0 A								
		per input pin; nI0, nI1 inputs	-	40	144	-	180	-	196	μA
		per input pin; OE input	-	135	486	-	608	-	662	μA
		per input pin; S input	-	70	252	-	315	-	343	μA
CI	input capacitance		-	3.5	-					pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); For test circuit see Figure 8.

Symbol	Parameter	Conditions		25 °C		–40 °C to +85 °C	–40 °C to +125 °C	Unit
				Тур	Max	Max	Max	
74HC257	7	· · ·						
t _{pd}	propagation delay	nl0 to nY or nl1 to nY; see <u>Figure 6</u>	<u>[1]</u>					
		V _{CC} = 2.0 V		36	110	140	165	ns
		$V_{CC} = 4.5 V$		13	22	28	33	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		11	-	-	-	ns
		$V_{CC} = 6.0 V$		10	19	24	28	ns
		S to nY; see Figure 6						
		$V_{CC} = 2.0 V$		47	150	190	225	ns
		$V_{CC} = 4.5 V$		17	30	38	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		14	-	-	-	ns
		$V_{CC} = 6.0 V$		14	26	33	38	ns
t _{en}	enable time	OE to nY; see Figure 7	[2]					
		V _{CC} = 2.0 V		33	150	190	225	ns
		$V_{CC} = 4.5 V$		12	30	38	45	ns
		$V_{CC} = 6.0 V$		10	26	33	38	ns
t _{dis}	disable time	OE to nY; see Figure 7	<u>[3]</u>					
		V _{CC} = 2.0 V		41	150	190	225	ns
		$V_{CC} = 4.5 V$		15	30	38	45	ns
		V _{CC} = 6.0 V		12	26	33	38	ns

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Symbol	Parameter	Conditions	Conditions		°C	–40 °C to +85 °C	–40 °C to +125 °C	Unit
				Тур	Max	Max	Max	
t _t	transition time	see Figure 6	<u>[4]</u>					
		V _{CC} = 2.0 V		14	60	75	90	ns
		$V_{CC} = 4.5 V$		5	12	15	18	ns
		$V_{CC} = 6.0 V$		4	10	13	15	ns
C _{PD}	power dissipation capacitance	per multiplexer; $V_I = GND$ to V_{CC}	•					pF
74HCT2	57		I					1
t _{pd}	propagation delay	nl0 to nY or nl1 to nY; see <u>Figure 6</u>	<u>[1]</u>					
		V _{CC} = 4.5 V		16	30	38	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		13	-	-		ns
		S to nY; see Figure 6						
		V _{CC} = 4.5 V		20	35	44	53	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		17	-			ns
t _{en}	enable time	\overline{OE} to nY; V _{CC} = 4.5 V; see <u>Figure 7</u>	[2]	15	30	38	45	ns
t _{dis}	disable time	\overline{OE} to nY; V _{CC} = 4.5 V; see <u>Figure 7</u>			30	38	45	ns
t _t	transition time	$V_{CC} = 4.5 V$; see Figure 6	<u>[4]</u>	5	12	15	18	ns
C _{PD}	power dissipation capacitance	per multiplexer; V _I = GND to V _{CC} – 1.5 V	<u>[5]</u>	45	-			pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); For test circuit see <u>Figure 8</u>.

 $\label{eq:tpd} [1] \quad t_{pd} \text{ is the same as } t_{PHL}, \, t_{PLH}.$

[2] t_{en} is the same as t_{PZH} , t_{PZL} .

- $[3] \quad t_{\text{dis}} \text{ is the same as } t_{\text{PHZ}}, t_{\text{PLZ}}.$
- $\label{eq:ttime_time} [4] \quad t_t \text{ is the same as } t_{THL}, \, t_{TLH}.$

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where: $f_i = \text{input frequency in MHz};$

 $r_i = input frequency in MHZ;$

 $f_o =$ output frequency in MHz;

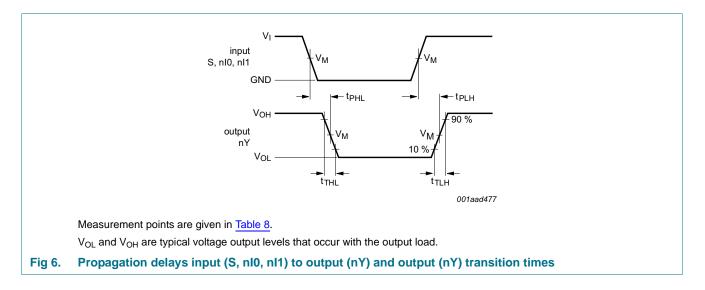
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V; N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

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11. Waveforms



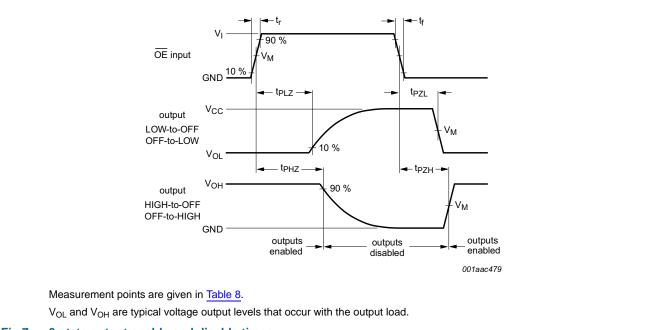


Fig 7. 3-state output enable and disable times

Table 8. Measurement points

Туре	Input	Output
	V _M	V _M
74HC257	0.5V _{CC}	0.5V _{CC}
74HCT257	1.3 V	1.3 V

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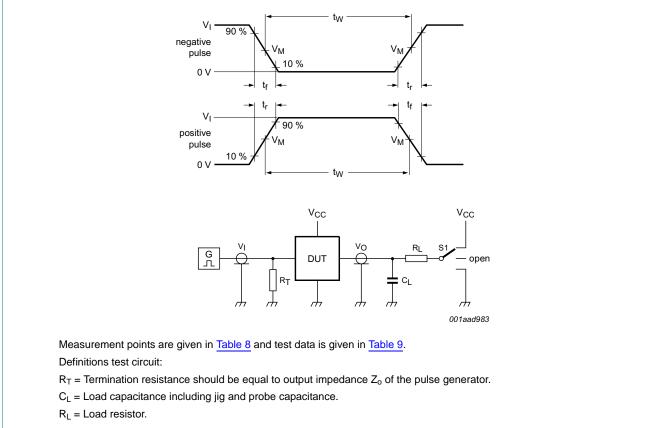


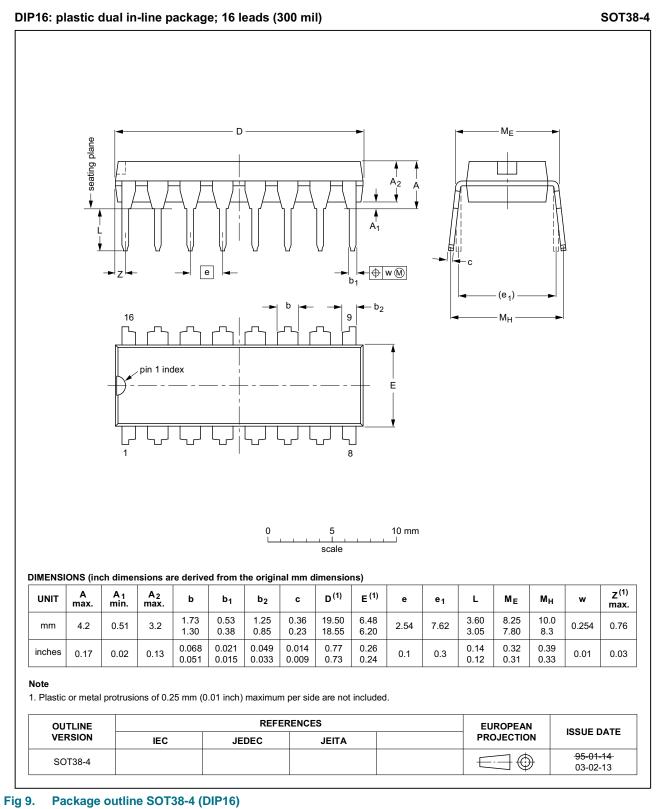
Fig 8. Test circuit for measuring switching times

Table 9. Test data

Туре	Input		Load	Load		Switch position		
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	
74HC257	V _{CC}	6 ns	50 pF	1 kΩ	open	GND	V _{CC}	
74HCT257	3 V	6 ns	50 pF	1 kΩ	open	GND	V _{CC}	

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12. Package outline



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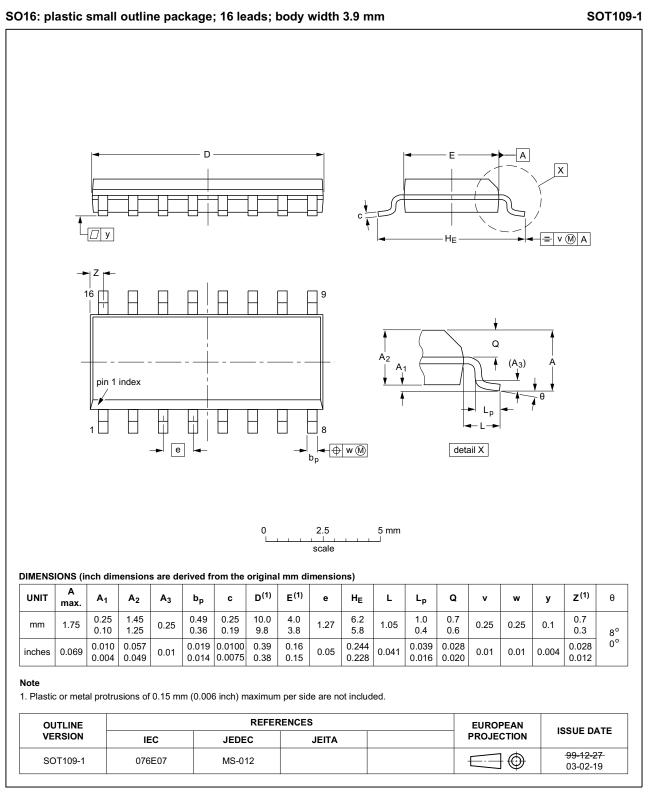


Fig 10. Package outline SOT109-1 (SO16)

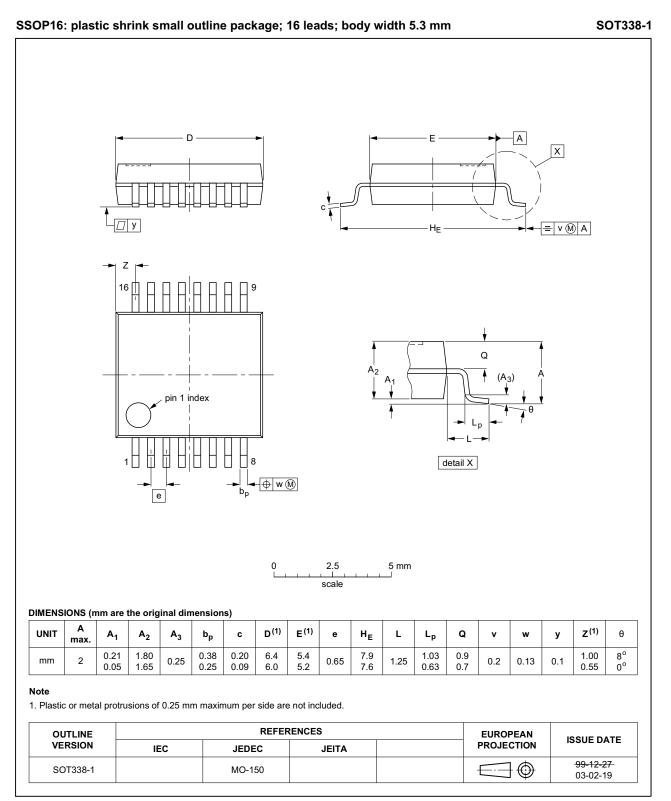


Fig 11. Package outline SOT338-1 (SSOP16)

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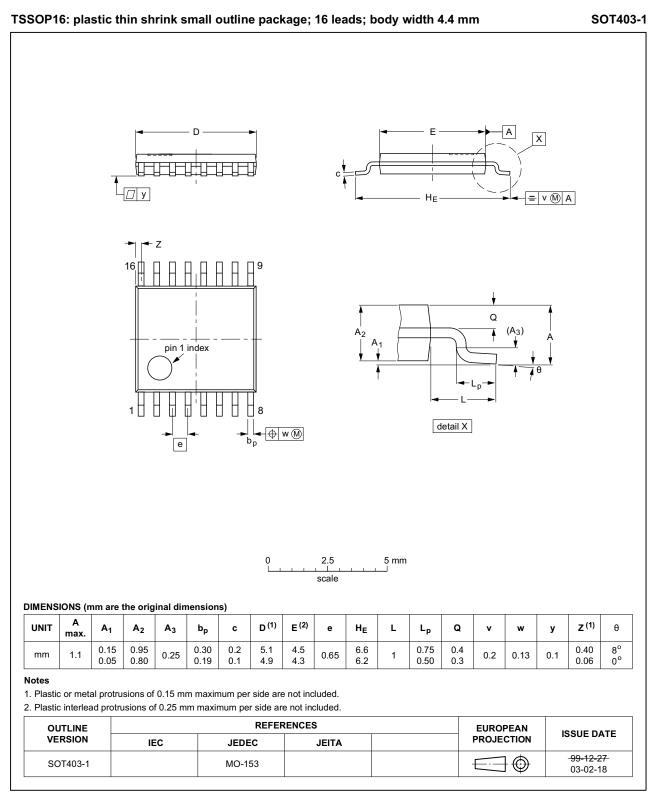


Fig 12. Package outline SOT403-1 (TSSOP16)

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13. Abbreviations

Table 10. Abbreviations		
Acronym	Description	
CMOS	Complementary Metal Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
НВМ	Human Body Model	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT257 v.6	20150126	Product data sheet	-	74HC_HCT257 v.5
Modifications:	• <u>Table 7</u> : Pov	ver dissipation capacitance	condition for 74H	CT257 is corrected.
74HC_HCT257 v.5	20100113	Product data sheet	-	74HC_HCT257 v.4
Modifications:	• <u>Table 7</u> : cha	nged 3OE to OE	·	
74HC_HCT257 v.4	20090608	Product data sheet	-	74HC_HCT257 v.3
74HC_HCT257 v.3	20050920	Product data sheet	-	74HC_HCT257_CNV v.2
74HC_HCT257_CNV v.2	19980930	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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